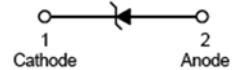


Surface Mount Zener Diode



SOD-123

Features:

- Planar Die Construction
- 500mW Power Dissipation On Ceramic PCB
- General Purpose, Medium Current
- Ideally Suited For Automated Assembly Processes

Applications:

- Zener diode
- Ultra-small surface mount package

Maximum Rating @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward voltage @ $I_F = 10\text{mA}$	V_F	0.9	V
Power dissipation	P_d	500	mW
Thermal resistance, junction to ambient air	$R_{\theta JA}$	305	$^\circ\text{C/W}$
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-65 to +150	$^\circ\text{C}$

Note : Device mounted on ceramic PCB; $7.6\text{mm} \times 9.4\text{mm} \times 0.87\text{mm}$ with pad areas 25mm^2

Short duration test pulse used to minimize self-heating effect.

When provided, otherwise, parts are provided with date code only, and type number identifications appears on reel only.

$f = 1\text{kHz}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Type Number	Marking Code	Zener Voltage Range				Maximum Zener Impedance			Maximum Reverse Current		Typical Temperature Coefficient @ I_{ZTC} mV/ $^\circ\text{C}$		Test Current I_{ZTC}
		$V_Z @ I_{ZT}$			I_{ZT}	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK}$	I_{ZK}	I_R	@ V_R			
		Nom(V)	Min(V)	Max(V)	mA	Ω		mA	μA	V	Min	Max	mA
BZT52C18	WL	18	16.8	19.1	5	45	225	1	0.1	12.6	12.4	16	5

Surface Mount Zener Diode



Typical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

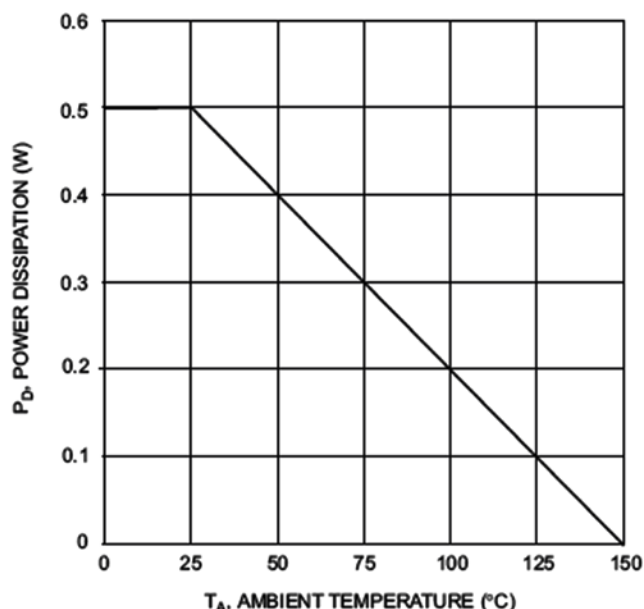


Fig. 1 Power Dissipation vs Ambient Temperature

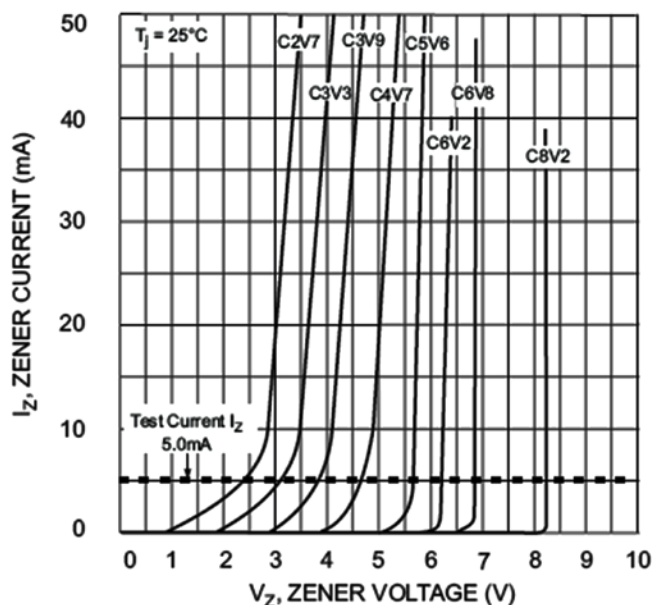


Fig. 2 Zener Breakdown Characteristics

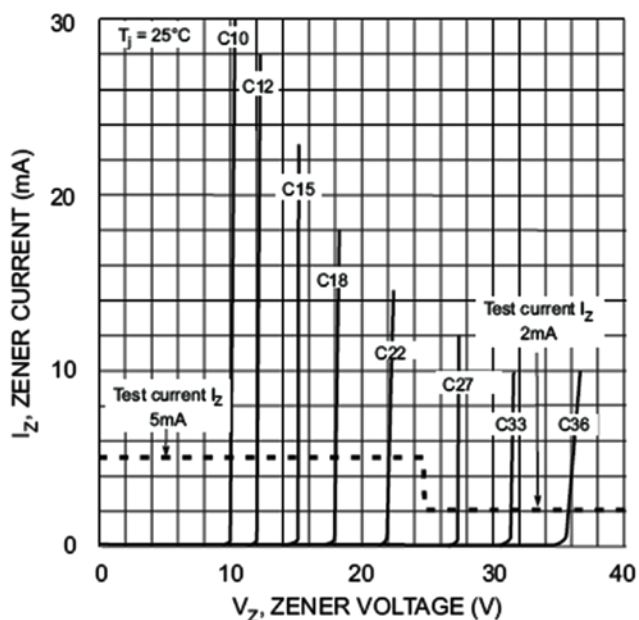


Fig. 3 Zener Breakdown Characteristics

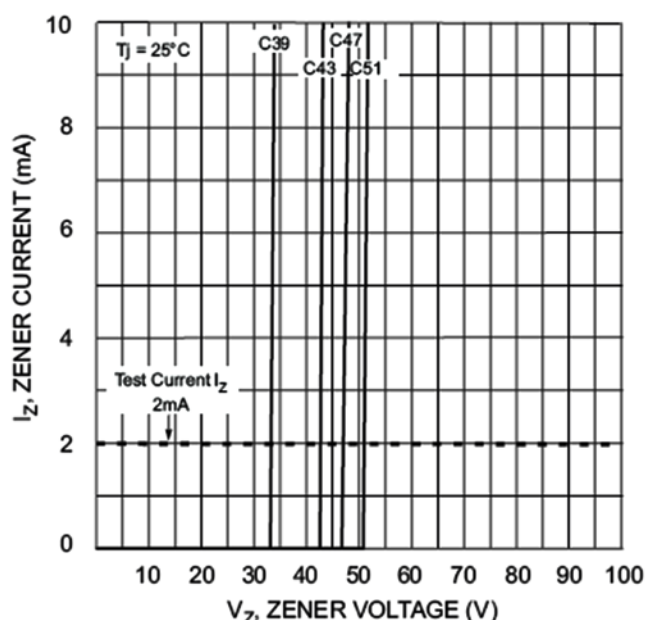


Fig. 4 Zener Breakdown Characteristics

Surface Mount Zener Diode

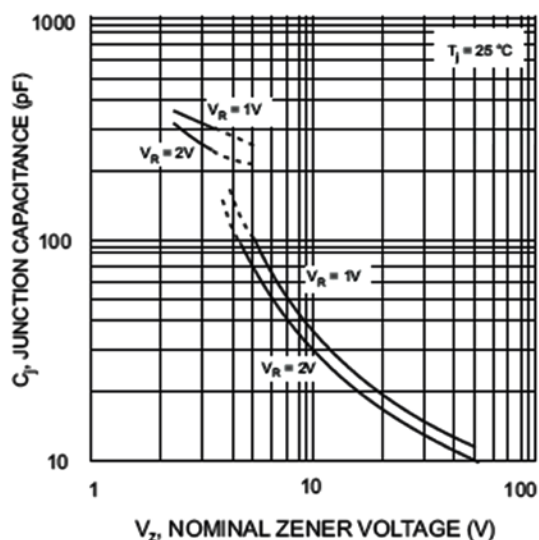
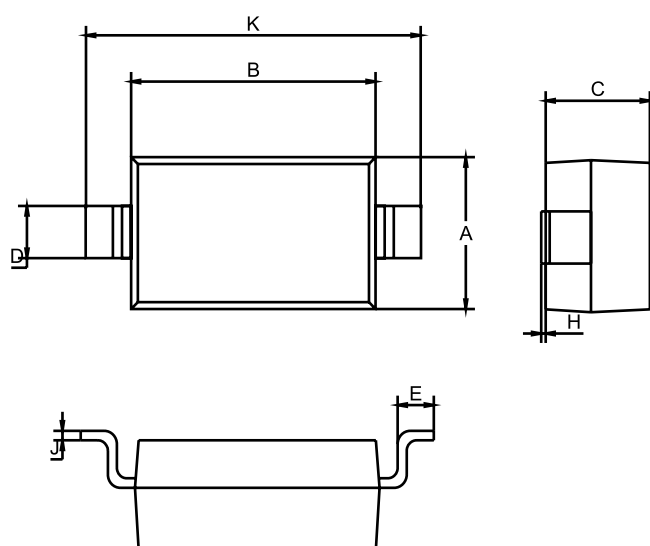


Fig. 5 Junction Capacitance vs Nominal Zener Voltage

Package Outline

Plastic surface mounted package

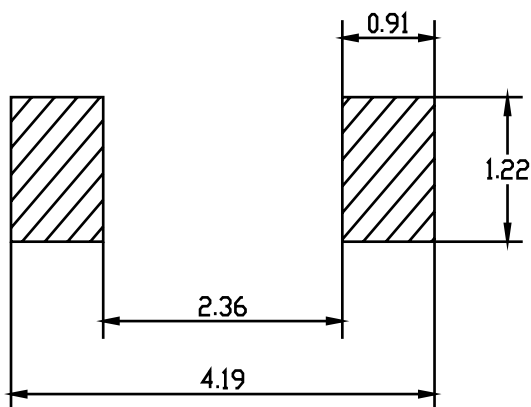


SOD-123		
Dim	Min	Max
A	1.4	1.8
B	2.55	2.85
C	1.15 Typical	
D	0.5	0.6
E	0.3	0.4
H	0.02	0.10
J	0.1 Typical	
K	3.55	3.85
All Dimensions in mm		

Surface Mount Zener Diode



Soldering Footprint



Dimensions : Millimetres

Package Information

Device	Package	Shipping
BZT52C18-7-F	SOD-123	3,000/Tape & Reel

Part Number Table

Description	Part Number
Surface Mount Zener Diode	BZT52C18-7-F

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